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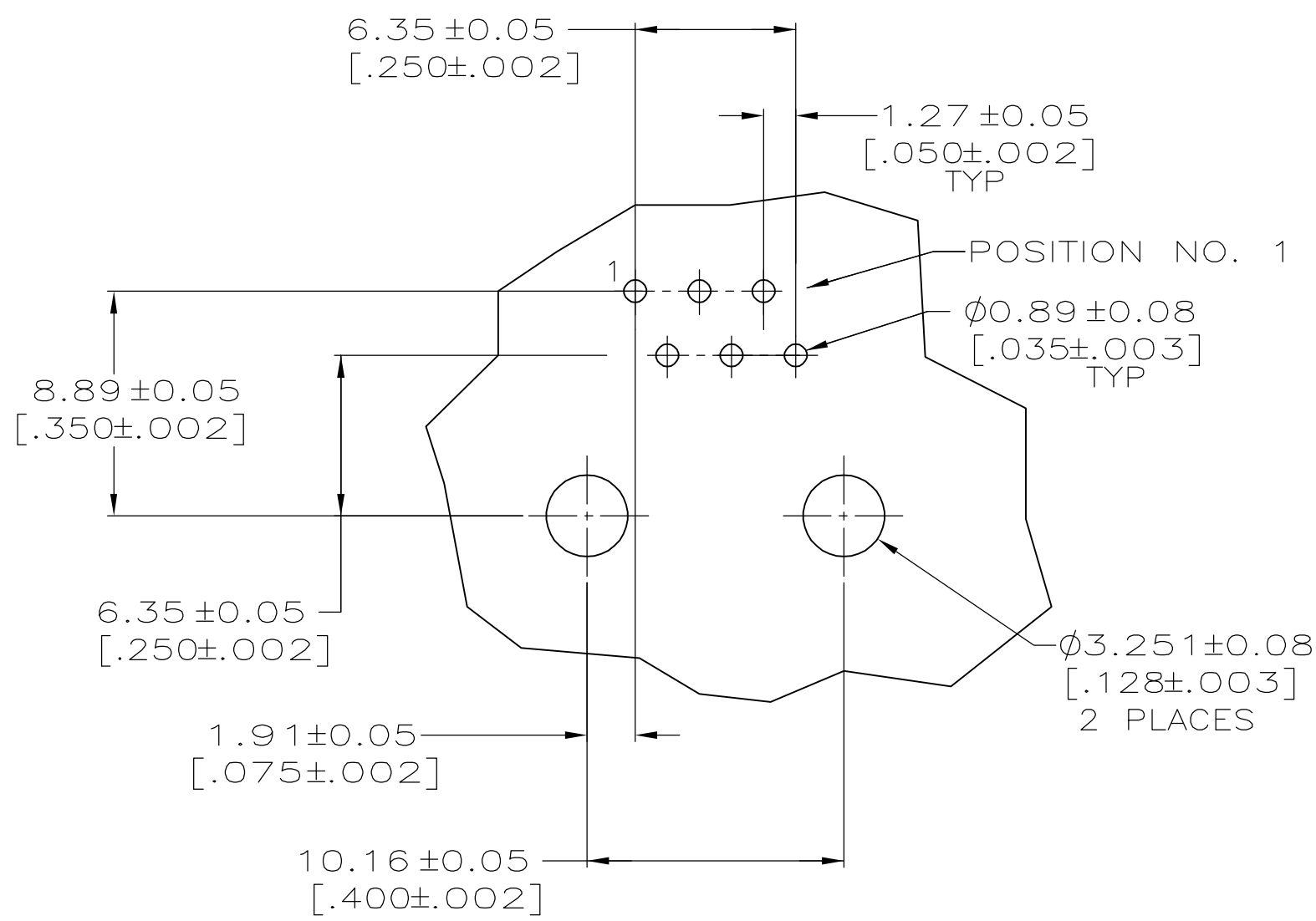
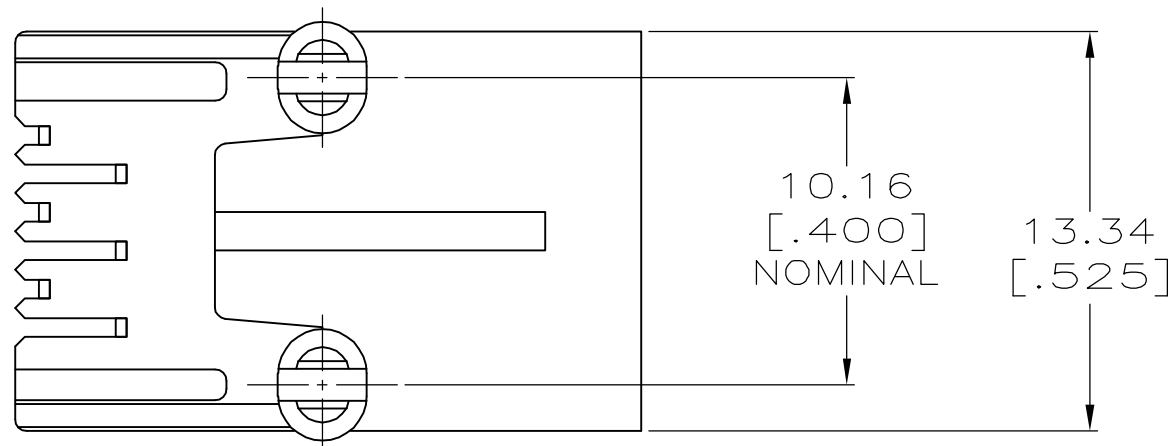
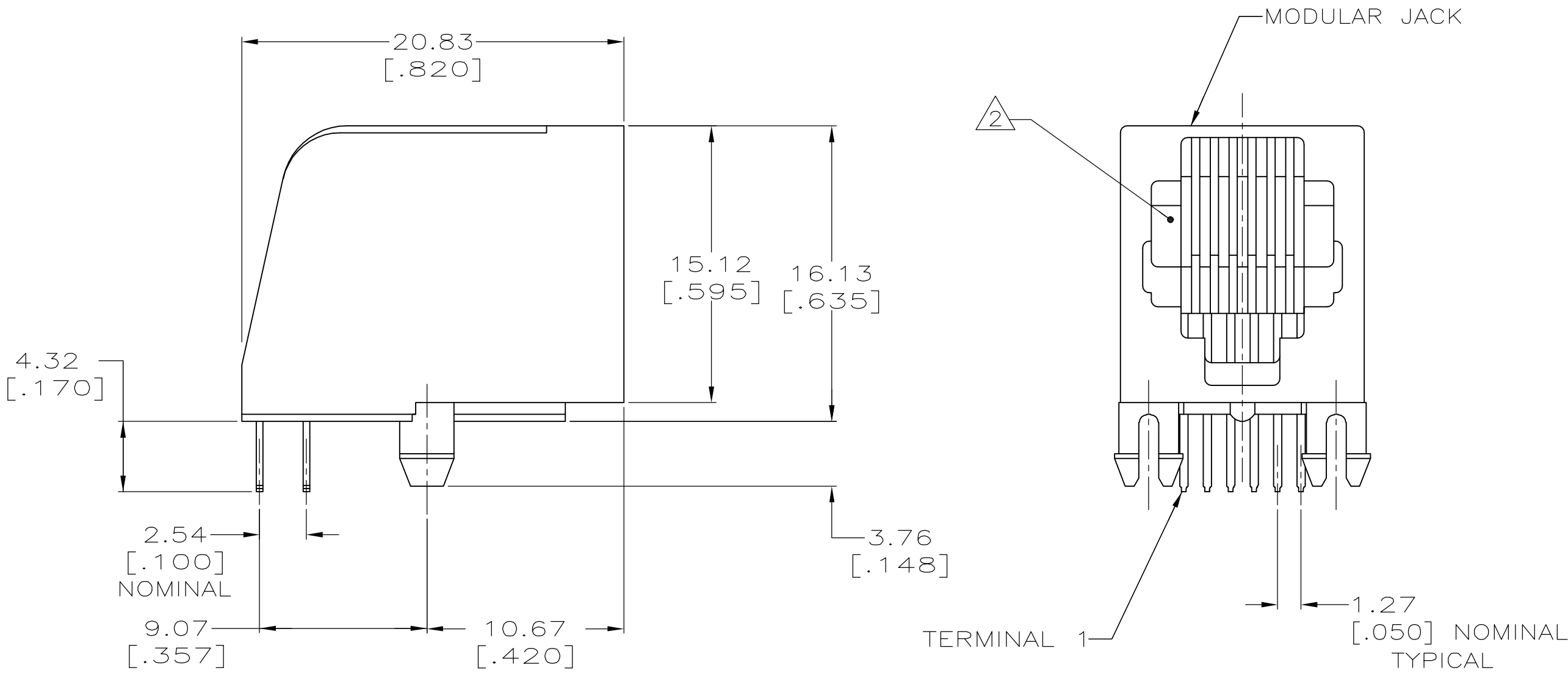
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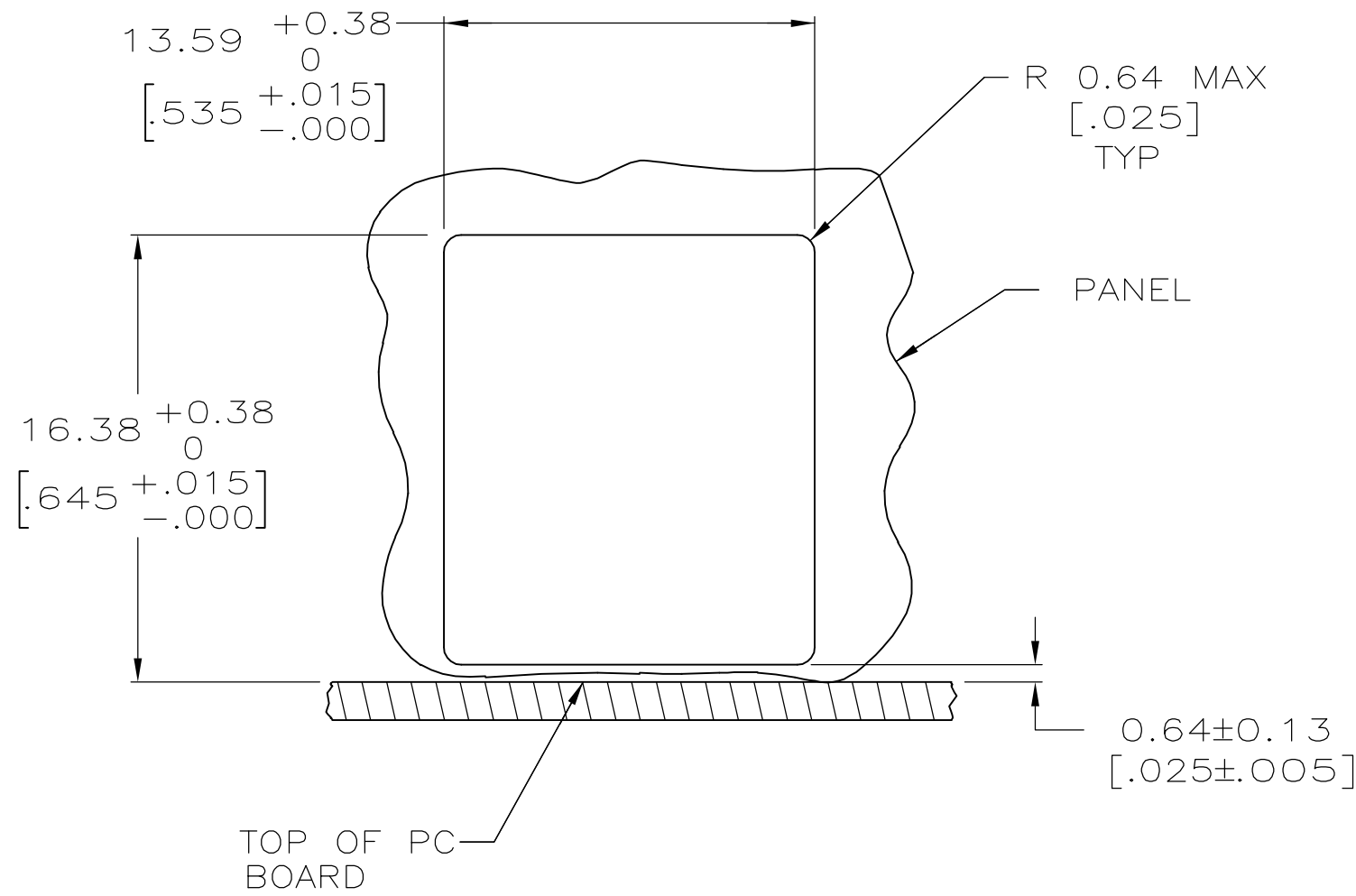
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Jameco Part Number 754566

LOC	DIST	REVISIONS					
AA	22	P	LTR	DESCRIPTION	DATE	DWN	APVD
			A	REV PER EC 0S11-0201-04	07JUN2005	GA	SF



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
COMPONENT SIDE



PANEL CUTOUT

- ⚠ MATERIAL: HOUSING – PBT POLYESTER, BLACK
TERMINAL – 0.36[.014] THICK PHOS-BRONZE
PLATED WITH 1.27µm[.000050] MINIMUM THICK
HARD GOLD IN LOCALIZED GOLD PLATE AREA
AND 3.81µm[.000150] MINIMUM THICK MATTE
TIN IN SOLDER AREA OVER 1.27µm[.000050]
MINIMUM THICK NICKEL UNDERPLATE.
- ⚠ CAVITY CONFORMS TO FCC RULES AND
REGULATIONS PART 68 AND REA BULLETIN
345-81, PE-76 SPECIFICATION FOR MODULAR
TELEPHONE HARDWARE.
- ⚠ DIMENSIONS ARE MAXIMUM UNLESS OTHERWISE
SPECIFIED.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN G. ATTADIA – 07JUN2005	Tyco Electronics Corporation Harriaburg, PA 17105-3608	
		CHK J. WESTMAN – 07JUN2005		
		APVD S. FLICKINGER – 07JUN2005		
DIMENSIONS: mm[inches]		PRODUCT SPEC 108-1163	NAME MODULAR JACK ASSEMBLY, SIDE ENTRY, 6 POSITION, FLANGELESS	
		APPLICATION SPEC 114-2048	SIZE A1	
MATERIAL ⚠		WEIGHT —	RESTRICTED TO —	
		CUSTOMER DRAWING	SCALE 4:1	
			SHEET 1 of 1	
			REV A	